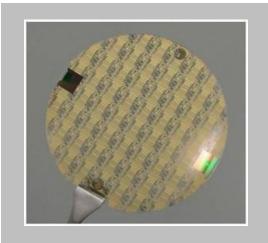
Foundry Process Data Sheet



GH15-1x



Description

This 0.15µm HEMT process is optimized for high power applications up to 45GHz. The good HEMT noise performance allows also LNA design.

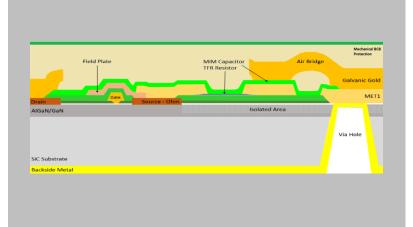
The process includes two metal interconnect layers, precision TaN resistors, high values TiWSi resistors, MIM capacitors with standard and high density, air-bridges and via-holes through the substrate.

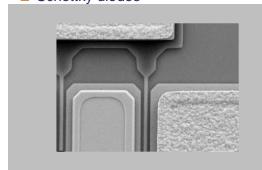
GH15 is available in four technology versions:

- GH15-10, Space evaluated
- GH15-11, providing additional options, such as High Density MIM 355pF/mm2 and BCB mechanical protection for compatibility with plastic molded packaging.
- GH15-12, providing mechanical and humidity protection
- GH15-13, with thinner substrate specially optimized for Q-band applications

Main Features

- 0.15µm GaN on SiC HEMT process
- Power density: 4.2 W/mm
- TaN and TiWSi resistors
- M.I.M. capacitors & inductors
- Air bridges
- Via-holes
- Operation Vds= 25V
- Vbds > 60V
- Wafer thickness: 70/50 µm ■ Wafer diameter: 100mm
- Schottky diodes





Design Kit Characteristics

- Available for ADS by Keysight, MwO by CADENCE
- Non-linear electro-thermal model for source grounded FET
- Noise model for LNA design
- Switch and diode models
- Scalable models for passive and activedevices.

Electrical Characteristics

ELEMENT / Parameters	Min	Тур	Max	Units	Conditions
FET /	_				
Threshold voltage Vp	-3.7	-3.0	-2.3	V	Vds=7.0V
					lds=ldss/100
Transconductance Gm	325	405	-	mS/mm	Vds=7.0V, Vgs=V _{GMMax}
Saturation current Idss	1350	1450	1550	mA/mm	Vds=7.0V, Vgs=3V
Coplanar FET (2x75μm) equivalent circuit					
Transconductance Gme	23	30	38	mS	
Input capacitance Cin	105	125	145	fF	
Feedback capacitance Cf	13	18	23	fF	
Tan resistor /					
sheet resistance	26	30	34	Ω/square	
MIM CAPACITOR /					
Standard Density	160	175	190	pF/mm2	
High Density (GH15-11/-13)	330	355	380		
TiWSi RESISTOR /					
sheet resistance	800	1000	1200	Ω/square	

Ordering Information

Visit our Website for more info: http://www.ums-rf.com

Please contact our Sales at: <u>marketing.sales@ums-rf.com</u> & Tel: +33 1 69 86 32 00 / Fax: + 33 1 69 86 34 34

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